



N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A)		
60	0.011 @ V _{GS} = 10 V	15.8		
	0.013 @ V _{GS} = 6 V	14.5		

FEATURES

- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance PowerPAK® Package with Low 1.07-mm Profile

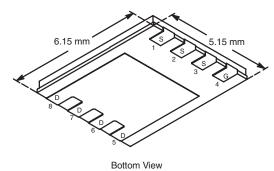








PowerPAK SO-8

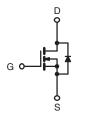


Ordering Information: Si7370DP-T1

Si7370DP-T1—E3 (Lead (Pb)-Free)

APPLICATIONS

- Primary Side Switch for 24-V DC/DC Applications
- Secondary Synchronous Rectifier



N-Channel MOSFET

Parameter		Symbol	10 secs Steady State		Unit
Drain-Source Voltage		V _{DS}	60		V
Gate-Source Voltage		V_{GS}	4		
Continuous Drain Current (T _J = 150°C) ^a	T _A = 25°C	I _D	15.8	9.6	
	T _A = 70°C		12.6	7.7	
Continuous Source Current		I _S	4.7	1.7	Α
Pulsed Drain Current		I _{DM}	50		
Avalanche Current		I _{AS}	50		
Single Avalanche Energy		E _{AS}	125		mJ
Maximum Power Dissipation	T _A = 25°C	P _D	5.2	1.9	W
	T _A = 70°C] ' ^D	3.3	1.25	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{b,c}			260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marrian III I American	t ≤ 10 sec	R _{thJA}	19	24	°C/W
Maximum Junction-to-Ambient ^a	Steady State		52	65	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	1.5	1.8	

Notes

a. Surface Mounted on 1" x 1" FR4 Board.
b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is

not required to ensure adequate bottom side solder interconnection.
c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

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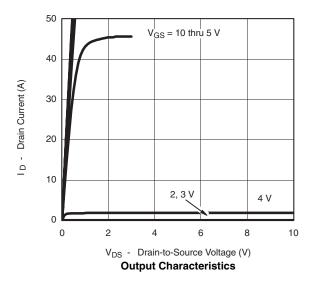
SPECIFICATIONS $T_J = 25 ^{\circ}\text{C}$, unless otherwise noted							
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static			•	•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V			1		
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 12 A		0.009	0.011		
		$V_{GS} = 6.0 \text{ V}, I_D = 10 \text{ A}$		0.0105	0.013	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		50		S	
Diode Forward Voltage ^a	V_{SD}	$I_S = 3.0 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.2	V	
Dynamic ^b	l l		•	.			
Total Gate Charge	Q_{g}			46	57		
Gate-Source Charge	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 12 \text{ A}$		11.5		nC	
Gate-Drain Charge	Q _{gd}			11.5			
Gate Resistance	R_g		0.2	0.85	1.2	Ω	
Turn-On Delay Time	t _{d(on)}			16	25		
Rise Time	t _r	V_{DD} = 30 V, R_L = 30 Ω		12	18		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1.0 A, V_{GEN} = 10 V, R_G = 6 Ω		50	75	ns	
Fall Time	t _f			30	45		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3.0 A, di/dt = 100 A/μs		40	60		

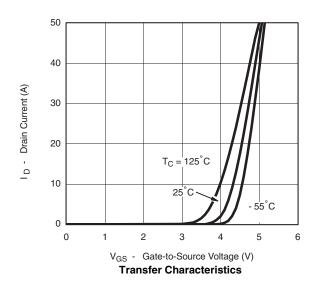
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C unless noted



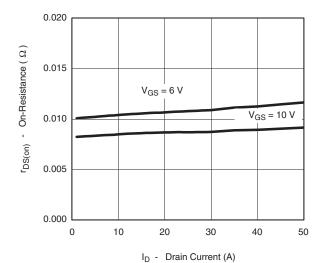




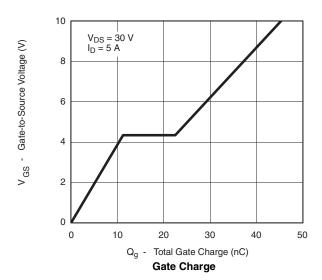


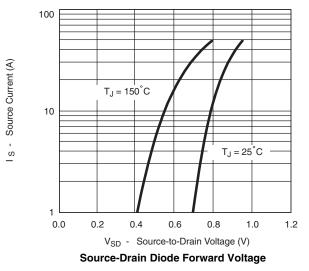


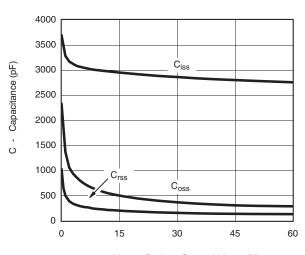
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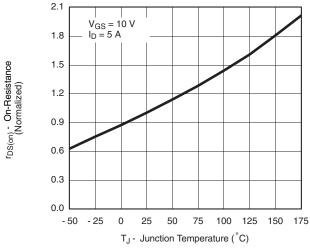
On-Resistance vs. Drain Current



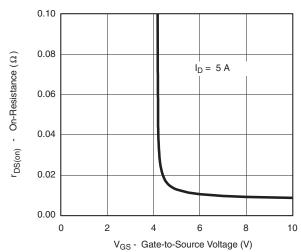




V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature

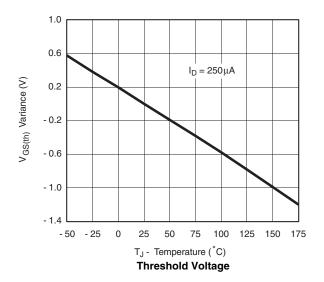


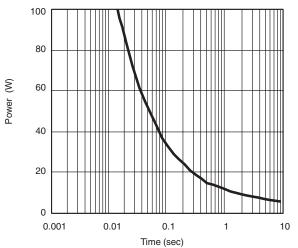
On-Resistance vs. Gate-to-Source Voltage

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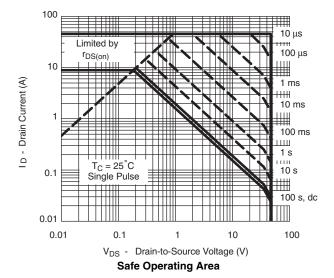
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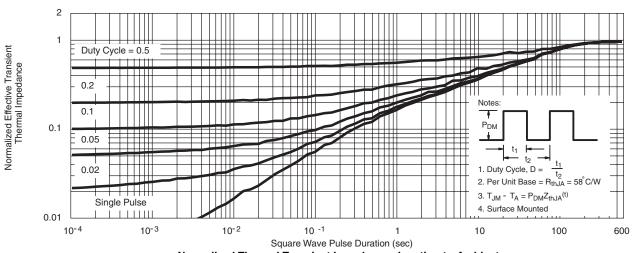
TYPICAL CHARACTERISTICS 25 °C unless noted





Single Pulse Power, Juncion-To-Ambient

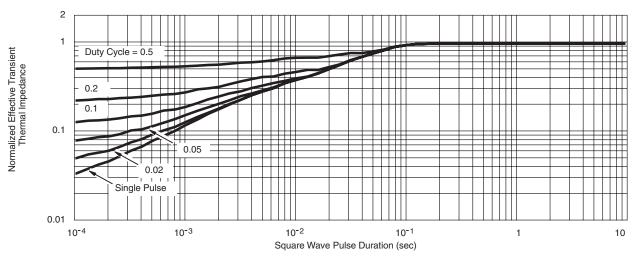




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C unless noted



Normalized Thermal Transient Impedance, Junction-to-Case

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